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# (0.80 mm) .0315" PITCH • QRM8/QRF8 SERIES

QRM8

#### QRM8 **Board Mates:** QRF8

QRF8 **Board Mates:** ORM8

#### QRM8/QRF8

Cable Mates: **EQRD** 

### **SPECIFICATIONS**

Insulator Material: QRM8 Terminal Material: Phosphor Bronze QRF8 Contact Material: Ground Plane Material: Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: Contact: 2.2 A per pin (2 pins powered) Ground: 8.5 A per ground plane (1 ground plane powered)
Operating Temp Range:
-55 °C to +125 °C Voltage Rating: 215 VĂ( Max Cycles:

#### PINS PER ROW **PLATING LEAD STYLE** OTHER OPTIONS **TYPF** NO. OF PINS **OPTION** -026, -052, -02.0-L -D -GP = 2 mm = 10 µ" Single = Guide Post -078 (0.25 µm) Gold Body Height (N/A -054 & Ended (52 total pins per bank = -D) on contact. -K = (5.00 mm) .197" DIA Polyimide Film Pick & Place -078 Positions) Matte Tin -D-DP on tail = Differential -018, -036. -05.0 Pair Pad -054= 5 mm Body (18 pairs per bank = -D-DP) Height –TR = Tape & Reel (-018, -026, -036, -052 only) -07.0= 7 mm Body Height -FR = Full Reel Tape & Reel (must order maximum No. of Banks x (24.80) .976 + (1.77) .070 quantity per reel; contact Samtec for quantity breaks) (-018, -026, -036, -052 only) (2.20) (1.32) .052 LEAD STYLE Α В ¥ (4.81)(6.12)-02 No. of Banks x (24.80) .976 - (1.10) .043 .241 .189 (7.81)(9.12)-05 .307 .359 (9.78)(11.12) -07 No. of Banks x (24.80) .976 + (3.55) .140 .385 .438 -GP OPTION

View complete specifications at: samtec.com?QRM8

# **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (018-026)

0.15 mm) .006" max (036-078)\* \*(.004" stencil solution may be available; contact

IPG@samtec.com)
Board Stacking:

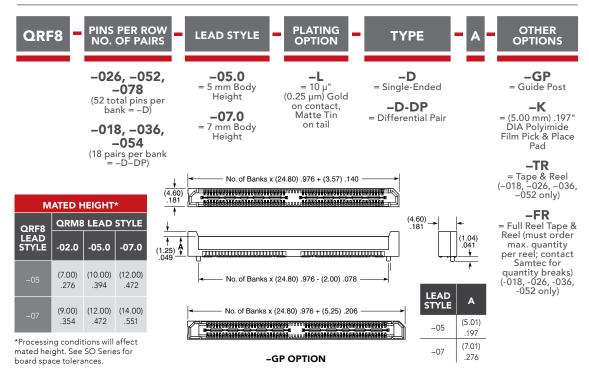
For applications requiring more than two connectors contact ipg@samtec.com





## Note:

Some lengths, styles and options are non-standard, non-returnable.



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